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Core/shell BCN@Cu heterostructures via electroless deposition for interface-tailored electroactive materials†

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Boron carbon nitrides (BCN) are semiconductors with tunable electronic band structures, and their heteropolar B and N bonding makes them suitable for electrochemical energy conversion applications. The latter is, however, restricted by poor control over phase formation as the properties of BCN strongly depend on the microstructure and the formed phases. A novel hybrid approach was utilized to control the BCN phase formation by combining mechanical alloying through ball milling and subsequent calcination at 400, 450, and 500 °C. In the next step, a thin layer of copper was deposited onto the BCN particles by electroless plating with and without prior surface activation using Pd²⁺ cations. Copper oxide was deposited on the as-prepared surface, whereas a core/shell Cu@BCN structure was formed by surface activation. The obtained heterostructures were tested in the direct electrochemical reduction of nitrate ions to ammonia (NO₃RR), a reaction of great promise for green ammonia synthesis in the future. Linear sweep voltammetry was carried out in a standard three-electrode electrochemical setup for alkaline NO₃RR at room temperature, and a current density of −19.2 mA cm^{−2} at −0.4 (V vs. RHE) and an ammonia faradaic efficiency (FE) and yield of 98.6% and 0.36 μg mg^{−1} s^{−1} were obtained after a 30 min electrolysis in 0.1 M KNO₃, respectively.

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1. Introduction

Boron-nitride (BN), and especially boron carbon nitride (BCN), materials attracted significant attention due to their tunable electronic and structural properties.^{1,2} In the ternary system of B–C–N, phases with covalent bonding, such as diamond, graphite, B₄C, BN (both cubic and hexagonal), and g-C₃N₄, are notably stable. This stability facilitates the formation of BCN from these initial materials, with BC₄N and BC₂N being the most stable among the possible B_xC_yN_z phases.³ Generally, BCN is synthesized as thin layers or powders for catalytic applications across various fields. While BCN layers have been successfully formed *via* PECVD,^{4,5} and ion beam assisted PLD,⁶

synthesizing BCN in powder form remained challenging. A well-known issue is the poor reproducibility of BCN syntheses, which often result in varying properties and stoichiometry despite using identical methods.¹ Several synthetic routes exist for BCN production, each with limitations on purity and composition. The variability in reactivity and stability of BCN precursors during synthesis can lead to unwanted side reactions or impurities, impacting the quality of the final product.⁷ Additionally, precursor availability and structural complexity pose further challenges in synthesizing high-quality BCN compounds. Thus, developing reliable synthesis methods using accessible precursors is crucial. A promising new route could be the transformation of B- and N-containing metal–organic frameworks (MOF) precursors, as the decomposition of MOFs results in high specific surface area doped carbon nanomaterials of various dimensionality,⁸ even carbon nanotubes (CNT).⁹

Several complex and sophisticated methods exist for the fabrication of thin metal layers on various substrates, like chemical vapor deposition (CVD), physical vapor deposition (PVD), or atomic layer deposition (ALD).¹⁰ Boron-nitride-based Cu/BN composites are well-known in the literature,¹¹ nevertheless BCN-supported systems were also prepared by thermal

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condensation of copper nitrate to zerovalent Cu nanoparticle-decorated BCN¹² and Cu₂O/BCN¹³ for dye degradation and photocatalytic hydrogen evolution, respectively. Electroless plating (ELP) or electroless metallization is the autocatalytic deposition of metals at the solid–liquid interface without using any external power source, *i.e.*, utilizing a redox reaction between the reducing agent in the plating bath and the metal ions being deposited onto the substrate. ELP was successfully used to deposit a wide range of metals, including copper.¹⁴ Yet, no study has been found on the preparation of Cu/BCN *via* electroless plating, a cost-effective and simple method for fabricating Cu thin layer on BCN support.

Ammonia is one of the most essential industrial feedstocks traditionally produced by the energy- and carbon-intensive Haber–Bosch process.¹⁵ The direct electrochemical reduction of nitrate or nitrite (NO₃RR) to ammonia is the technology of the future currently limited by low selectivity and yield,¹⁶ while nitrate (NO₃[−]) and nitrite (NO₂[−]) ions, on the other hand, have a detrimental impact on the environment. NO₃RR is a promising route for mitigating the effect of nitrite and nitrate stress and the carbon footprint of ammonia synthesis at the same time.¹⁷ Application of BCN compounds for electrocatalysis is scarce due to the generally low activity and poor synthesis reproducibility. The combination of BCN and an active co-catalyst can improve catalytic performance. For example, Kokulnathan *et al.* reported the synthesis of 3D flower-like nickel oxide particles entrapped in BCN as a catalyst for the electrochemical detection of nitrofurantoin,¹⁸ and Li *et al.* embedded Pd nanocrystals in BC₂N for NO₃RR.¹⁹ Further literature results identify Cu-based systems as potential catalysts,²⁰ like cerium-doped copper nanocrystals,²¹ plasma-treated amorphous MnCuO_x,²² Cu₂O/Cu grown on Cu foam,²³ Cu₂O nanocubes,²⁴ Cu distributed as single atoms in the BCN matrix with Pd nanoparticles (Pd_xCu/BCN),²⁵ or even 3D printed Cu electrode.²⁶ To our knowledge, a single report deals with copper-containing co-catalyst on BCN for nitrate reduction.²⁵

Here, we developed a hybrid process combining mechanical alloying of simple and cost-effective precursors with calcination/pyrolysis for synthesizing boron carbon nitride. The as-prepared BCN was then used as a substrate for copper deposition to obtain a core/shell Cu/BCN structure *via* electroless plating with and without prior surface activation by Pd²⁺. The formed phases were studied by X-ray diffraction (XRD), the chemical state of B, C, and N was determined by X-ray photoelectron spectroscopy (XPS), and the morphology was investigated by electron microscopy (TEM, SEM). The obtained Cu/BCN composite was tested in alkaline NO₃RR at room temperature.

2. Experimental methods

2.1. Materials

Boric acid (H₃BO₃), urea (CH₄N₂O), nitrogen gas, and melamine (C₃H₆N₆) served as the source of boron, nitrogen, and

carbon, respectively. The copper electroless bath was prepared by using copper sulfate (CuSO₄·5H₂O), potassium sodium tartrate (KNaC₄H₄O₆·4H₂O), sodium hydroxide (NaOH), and formaldehyde (HCHO). PdCl₂ powders and HCl 30% were used for the surface activation treatment. All materials were used as received without any further purification steps.

2.2. Synthesis of boron carbon nitride (BCN)

In this procedure, a predetermined amount of melamine, urea, and boric acid at a ratio of 1:1:1 was poured into a Si₃N₄ container containing grinding balls of the same material. The ball-to-powder ratio was adjusted to 10:1, and ball milling was carried out at 450 rpm for 6 h. To obtain a homogenous milling and powder, a reverse rotation of the container once every 1 h was used. The obtained white powder was transferred to an alumina crucible and heated at 5 °C min^{−1} before being annealed at 400, 450, and 500 °C for 2 h under an argon atmosphere. After cooling down to room temperature, the resulting yellowish powders were grounded and labeled throughout the study as BCN-400, BCN-450, and BCN-500, respectively. Since challenges to BCN synthesis reproducibility are known in the literature, we synthesized more than 5 batches and verified their structure by comparing the corresponding XRD patterns to those achieved from the literature.

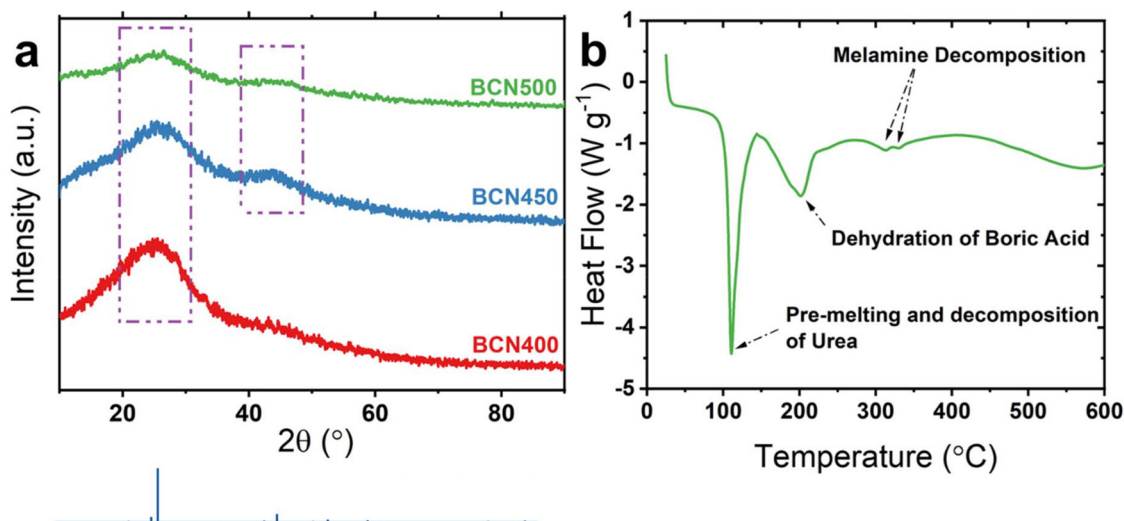
2.3. Synthesis of the Cu/BCN composite

The copper coating was applied on BCN *via* the electroless plating method. Prior to the electroless coating, surface activation was carried out, where 1 mg BCN was added to the solution of 0.75 g L^{−1} PdCl₂ in 15 mL L^{−1} HCl and stirred for 30 min. The activated BCN was settled out of the suspension, and the filtered and dried powder was subsequently introduced into the copper plating bath of 15 g L^{−1} Cu₂SO₄·5H₂O, 3.3 g L^{−1} NaH₂PO₄·H₂O as a reducing agent, and 6 g L^{−1} Na₂S₂O₃ as stabilizing agent at 60 °C for 10 min. The pH of the solution was kept between pH = 11–13 with the addition of 1 M NaOH solution. After precipitation, the composite was filtered and dried at 60 °C for 24 h, and the sample was labeled as Cu@BCN. The color of the obtained heterostructures varied from black to reddish brown (copper color). To demonstrate the importance of surface activation in electroless metallization, copper plating of BCN was repeated without Pd²⁺ pretreatment (BCN-Cu₂O).

2.4. Structural characterization

Fourier-transform infrared (FT-IR, Bruker Vertex 70) was used to investigate the functional groups on the surface of the obtained samples in the 4500–450 cm^{−1} wavenumber region at 4 cm^{−1} resolution, averaging 16 spectra in each measurement. FT-IR samples were prepared by compressing the samples with potassium bromide (KBr) at a ratio of 1:100 and a pressure of 10 kN for 2 min. Pure KBr powders served as a reference. Differential scanning calorimetry (DSC) measurements (Mettler-Toledo DSC 3+) were performed to study the thermodynamic state of the raw materials used for BCN synthesis in





around 110 °C (eqn (1)) before boric acid dehydration and melamine decomposition took place at 203 °C (eqn (2)) and at approx. 331 °C (eqn (3)), respectively. The reaction of the products of eqn (1)–(3) then finalize the $B_xC_yN_z$ formation (eqn (4)), hence the choice of temperature region ≥ 400 °C in this study. A similar mechanism was previously proposed by Mirzaee *et al.* using glucose instead of melamine.²⁹



The morphology of the obtained BCN was studied by scanning electron microscopy, and the corresponding SEM images of BCN-400, BCN-450, and BCN-500 are presented in Fig. 3. All samples have large, agglomerated particles and flake-like morphology, which are tightly adhered to form bigger granular particles, similarly to those reported previously by Bhattacharyya *et al.*³⁰ The size of the macropores visible in the granular particles increases by increasing calcination temperature with an average pore size of around 10 μm in BCN500. The effect of the heat treatment temperature was studied by Zhang *et al.*, and they found ribbons-forming porous compact lamellar structures with a semi-flower morphology.⁷ The origin of the porous structure can be attributed to the volatility (low

Sample	B (at%)	C (at%)	N (at%)
BCN400	22.8	21.2	28.7
BCN450	23.9	18.7	32.5
BCN500	26.9	18.6	27.9

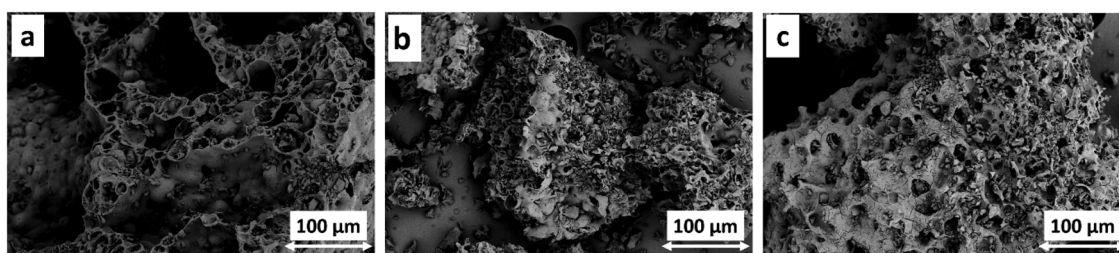


Fig. 3 Morphology of $B_xC_yN_z$ obtained at 400 °C (BCN400) (a), 450 °C (BCN450) (b), and 500 °C (BCN500) (c).

Fig. 4e, where density variations through the actual grain is the result of the varying particle thickness. Neither copper particles in the thin boundary layer nor copper islands on the BCN particles were found, like in the electrochemically deposited Cu on nickel foam.³⁹ The electron diffraction pattern (SAED) of Cu@BCN in Fig. 4f corresponds to the (111), (220), and (311) planes of metallic copper. The XRD patterns of the copper-plated BCN500 with and without surface activation were compared to that of the as-prepared BCN500 in Fig. 5a. Peaks at $2\theta = 43.5^\circ$, 50.6° , and 74.3° in the Cu@BCN pattern indicate the presence of a metallic copper layer in accordance with the SAED pattern of Fig. 4f above, whereas reflections at $2\theta = 37.1^\circ$, 43.3° , 62.2° , and 74.5° correspond to the Cu_2O phase. This implies that without surface activation copper(i)-oxide layer is formed on the BCN500 surface instead of metallic copper deposition. Additionally, by applying copper layer on BCN500, the zeta potential of the particles changed from 8.3 mV of the as-synthesized BCN500 to -25.3 mV for Cu@BCN. Zeta potential (electrokinetic potential, ζ) is the electrostatic potential at the boundary layer separating the surface species and the dispersion medium relative to that of the bulk solvent, and $\zeta \approx \pm 30$ mV is considered a stable suspension.

The FT-IR spectra of the coated and uncoated BCN500 are shown in Fig. 5b. Based on the report by Liu *et al.*, the peaks at around 1375 and 810 cm^{-1} correspond to the B–N stretching and B–N–B bending vibration, respectively. The peaks between 1260 – 1330 cm^{-1} , 1020 – 1220 cm^{-1} , and 1090 – 1300 cm^{-1} indicate the presence of C–C, C–N, and C–B bonds, respectively, confirming the formation of the B–C–N bond.⁴⁰ In another study by Zhou *et al.*, the peaks at 1380 and 780 cm^{-1} attributed

to the B–N and B–N–B bonds, respectively, and suggested the presence of the $\text{B}_x\text{C}_y\text{N}_z$.⁴¹ Thus, vibration spectroscopy indicates the formation of B–C–N bonds in all samples obtained via our hybrid synthesis method. In addition, Chen *et al.* showed that the bands of O–H/N–H stretching at 3440 cm^{-1} and C–H stretching at 2925 and 2854 cm^{-1} can be related to the presence of the pristine $\text{B}_x\text{C}_y\text{N}_z$.⁴² The IR spectrum of BCN500 changed upon copper and copper oxide deposition. However, the weak bands at 2934 and 2841 cm^{-1} were attributed to the CH_2 groups, including terminal groups of $-\text{CH}_3$ and $=\text{CH}$, which were previously detected for copper nanoparticles.⁴³ In Cu@BCN, peaks at 1609 and 1383 cm^{-1} likely originate from the asymmetric COO^- stretching related to carboxylate coordination to copper.⁴³ Also, applying a copper coating eliminated the peak of $\text{B}_x\text{C}_y\text{N}_z$ powders at 2188 cm^{-1} .

The XPS survey spectra for BCN500 and Cu@BCN are shown in Fig. 6, which confirms the successful deposition of the copper layer on BCN particles. The BCN500 sample contains only B, N, C, and O; no other impurity can be detected, as can be seen in Fig. 6a. The B 1s, C 1s, N 1s, and O 1s peaks are found at 187.3 , 286 , 398 , and 530 eV , respectively. Upon applying a copper layer on $\text{B}_x\text{C}_y\text{N}_z$ powders, the intensity of the B 1s, C 1s, N 1s, and O 1s peaks decreases, which can be attributed to the copper coverage of BCN500. The high-resolution B 1s and N 1s spectra of Cu@BCN in Fig. 6b and c show the presence of B–C (191.1 eV), and both sp^2 (399.5 eV) and sp^3 (398.2 eV) C–N bonds in the BCN substrate, which further confirms the successful BCN synthesis via the hybrid method.⁴⁴ The high-resolution Cu 2p spectrum of Cu@BCN (Fig. 6d) in the 928 – 947 eV region was fitted with a multiplet splitting structure including Cu(0)/Cu(I), Cu(II)/oxide, and Cu(II)/hydrox-

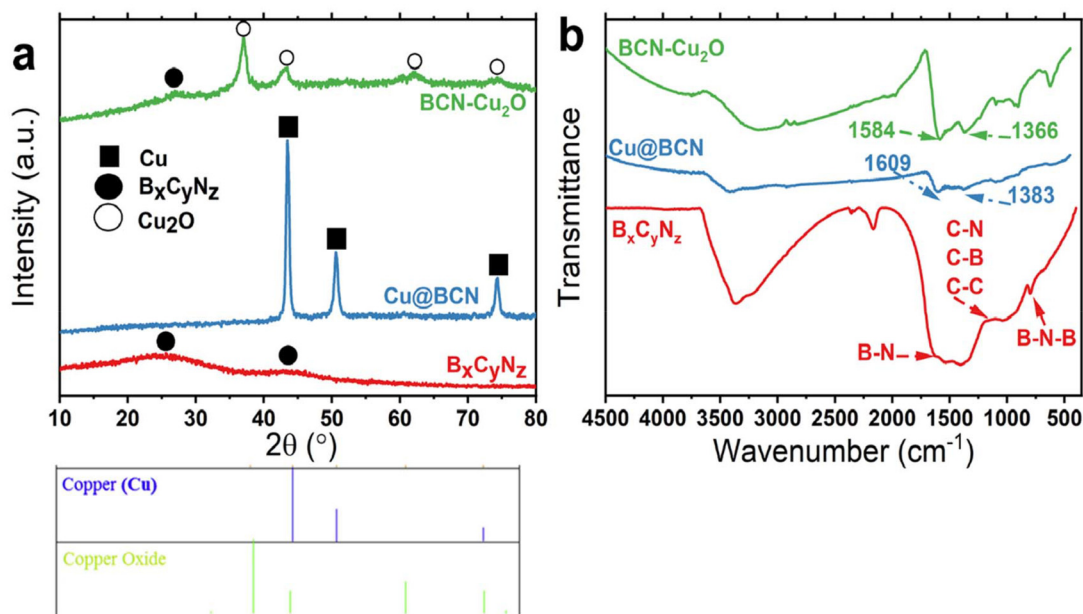


Fig. 5 XRD patterns (a), and FT-IR spectra (b) of the as-prepared BCN500, and the Cu/BCN composites prepared without (BCN- Cu_2O) and with surface activation (Cu@BCN). XRD patterns of copper and copper oxide are added for comparison.



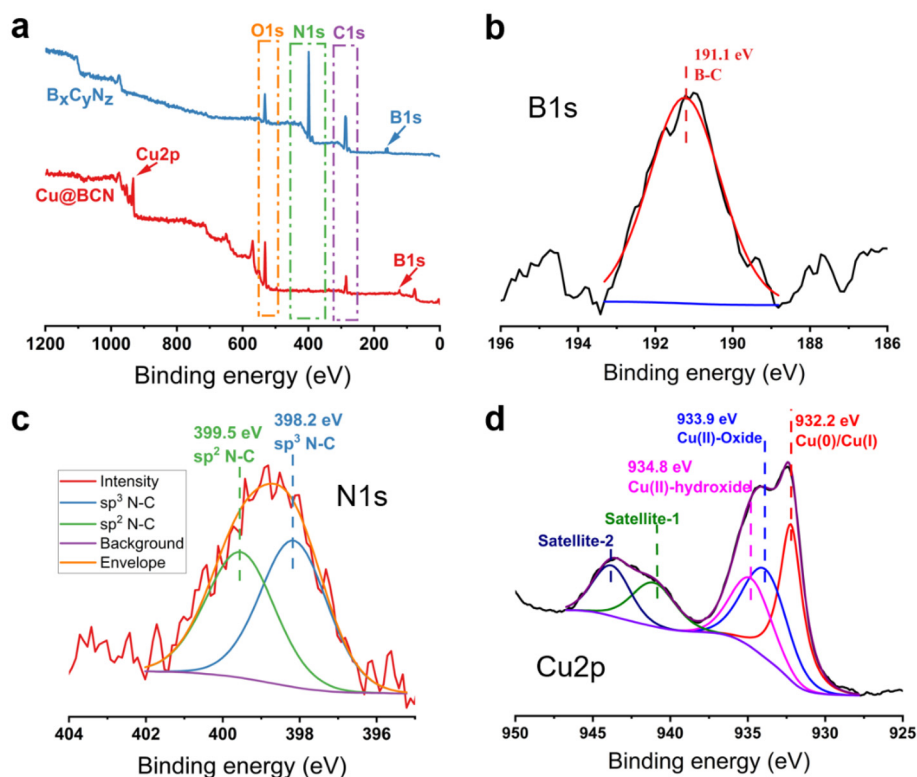


Fig. 6 XPS survey spectrum of BCN500 and Cu@BCN (a), and the high-resolution XPS spectra of B 1s (b), N 1s (c), and Cu 2p of Cu@BCN.

ide binding energy at 932.2, 933.9, and 934.8 eV, respectively. This is consistent with the results by Cerron-Calle *et al.*⁴⁵ The O 1s peaks can be originated from the adventitious carbon layer and the Cu compounds, while the intensity of the C 1s and N 1s peaks are almost identical in both samples, similarly to those reported by Lee *et al.* for boron and nitrogen co-doped graphene.⁴⁶ Detailed analysis of the high-resolution C 1s, O 1s, B 1s, and N 1s XPS spectra of BCN500 and the C 1s spectrum of Cu@BCN are depicted in Fig. S3.† Elemental composition of the two samples was calculated based on the peak areas corrected by the relative sensitivity factors based on Scofield cross-sections, and 5.2 at% of copper was found in the Cu@BCN composite (Table 2).

3.3. Electrochemical nitrate reduction

The NO₃RR activity of the Cu@BCN composite was evaluated by linear sweep voltammograms (LSV) recorded between −0.4 and 0.4 V (vs. RHE) under alkaline conditions in argon-purged 1 M KOH electrolyte at room temperature.⁴⁷ The obtained LSV curves with (NO₃RR) and without (HER) adding 0.1 M KNO₃

nitrate source to the electrolyte are presented in Fig. 7. It can be seen in Fig. 7a and b, that both samples, BCN500 and Cu@BCN, show some low water reduction activity (red lines), which increases in NO₃RR by the addition of nitrate ions (blue lines). However, the onset potential decreases upon copper deposition on BCN500 from −0.2 to −0.05 V (vs. RHE), reaching a current density of −4.74 and −19.20 mA cm^{−2} at −0.4 V (vs. RHE) for BCN500 and Cu@BCN, respectively. On Cu₂O-BCN, the onset potential was similar to that of BCN500 but with a steeper increase in current density towards more negative potentials, reaching a value of −5.69 mA cm^{−2} @ −0.4 V (vs. RHE) in Fig. 7c. Nitrate and water reduction (hydrogen evolution, HER) are competing processes, and even though the HER activity increased on Cu@BCN, the rise in the NO₃RR activity dominates the electrochemical behavior caused by the low activity and the hydrophobic feature of BN-based materials. CA experiments were carried out (Fig. S4†), and the amount of formed ammonia was determined by UV-vis spectroscopy (Fig. S5†). Yield rates were calculated *via* eqn (S2)† for BCN, Cu@BCN, and Cu₂O-BCN, and values of 0.73, 0.92, and 0.36 μg s^{−1} mg_{cat}^{−1} were obtained, respectively. Additionally, calculated FEs (according to eqn (S1)†) for BCN, Cu@BCN, and Cu₂O-BCN equal 96.5, 98.9, and 98.6%, respectively.

In electrochemical nitrogen reduction reaction (N₂RR), the source of N for the formation of ammonia is often some N-species in the sample or solvent residue, as it has been evidenced several times after the rigorous protocol on the N₂-to-NH₃ reaction was published.⁴⁸ However, considering the

Table 2 Elemental composition of BCN500 and Cu@BCN from XPS measurements

Sample	B (at%)	N (at%)	C (at%)	O (at%)	Cu (at%)
BCN500	18.4	39.2	28.6	13.8	—
Cu@BCN	1.7	2.8	53.5	36.8	5.2



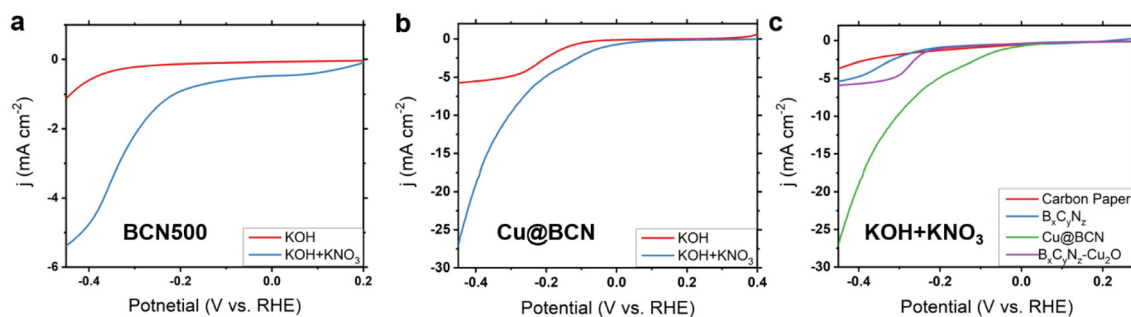


Fig. 7 Voltammetric (LSV) curves of BCN500 (a) and Cu@BCN (b) on carbon paper under alkaline conditions (1 M KOH) with and without the presence of nitrate ions (0.1 M KNO_3). Comparison of the NO_3RR activity of the bare carbon paper substrate, BCN500, and Cu@BCN in 1 M KOH + 0.1 KNO_3 electrolyte (c).

decomposition temperatures of urea (110 °C) and melamine (330 °C), it is unlikely that even a trace amount of the precursors remained in the product. If some ammonia was produced by the reduction of a trace amount of urea and melamine, we should see an elevated NO_3RR activity on pure BCN, whereas BCN was shown to be highly inactive in Fig. 7c. Moreover, it is worth noting that in N_2RR the interference of N-containing residue reduction is relevant due to the exceptionally low faradaic efficiency and yield. The amount of ammonia formed from this contamination could be comparable to that generated by the transformation of gaseous nitrogen reactant. In nitrate reduction, on the other hand, faradaic efficiency and ammonia yield are higher, and thus, the reduction of a trace amount of N-residue can simply be neglected. Furthermore, performing NO_3RR on isotope-labeled nitrate proved that ammonia is formed exclusively by the reduction of nitrate despite using an N-doped carbon framework-based Fe SAC catalyst.⁴⁹ Similar results were found on a Cu-based catalyst, as $^{15}\text{NH}_3$ originated solely from the transformation of isotope-labeled nitrate ions.³⁹

The obtained current density on Cu@BCN is higher than the values reported for copper foils, copper nanocubes, and copper nanosheets by Fu *et al.*⁵⁰ and for a CuCo compound by Wang *et al.*⁵¹ However, Zhao *et al.* obtained higher NO_3RR activity by distributed copper as single atoms in the B–C–N matrix with Pd nanoparticles ($\text{Pd}_{10}\text{Cu}/\text{BCN}$).²⁵ The charge transfer resistance of the carbon paper-based electrode was characterized by electrochemical impedance spectroscopy (EIS); the corresponding impedance spectra are seen in Fig. 8a. The diameter of the resulting semicircle in the Nyquist plot decreased in the BCN500– Cu_2O –BCN–Cu@BCN series, where the smallest semicircle of Cu@BCN implies the lowest charge transfer resistance among the samples.

Although there are no previous publications on Cu/BCN electrochemical nitrate reduction catalysts, a Cu-containing BCN-based system was studied in detail.²⁵ Here, Cu single atoms were dispersed into a BCN matrix with Pd nanoparticles ($\text{Pd}_x\text{Cu}/\text{BCN}$). DFT calculations showed that copper is most probably in the form of Cu^{2+} in a CuN_4 configuration, where the lower Fermi level, *i.e.*, higher electron affinity, favors NO_3^-

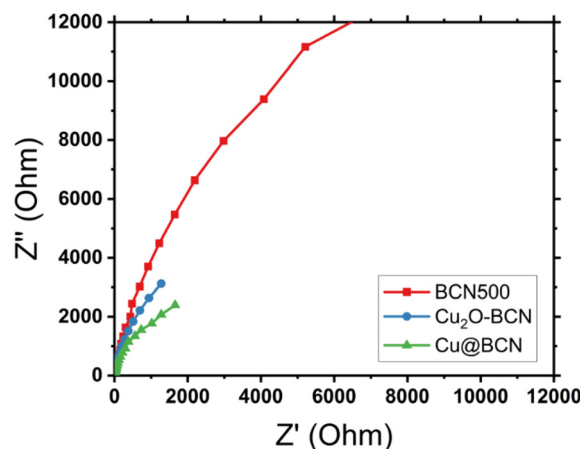


Fig. 8 Electrochemical impedance spectra (EIS) of BCN500, Cu_2O -BCN, and Cu@BCN deposited on carbon paper.

adsorption. It was also found that electrons are localized mainly on the B, C, and N atoms and delocalized on Cu and Pd. Calculations revealed electron transfer from BCN to Pd, but no electron transfer was observed between the two metal species. They found that BCN alone shows an order of magnitude lower NO_3RR activity compared to that of $\text{Pd}_x\text{Cu}/\text{BCN}$. And even when BCN sites are available in $\text{Cu}(\text{N}_4)/\text{BCN}$, nitrate adsorption energy is positive on B, C or N, whereas it is negative on copper. Thus, we propose that (a) Cu is the favored NO_3^- adsorption site, (b) nitrate transformation takes place on Cu active sites, and (c) electron transfer between the support and the active layer ($\text{BCN} \rightarrow \text{Cu}$) further enhances the NO_3RR activity. It is also worth noting that if some of the Pd used for surface activation were accessible for nitrate ions despite the full copper coverage and the lack of evidence of Pd in the XPS spectra in Fig. 6, strongly adsorbed active hydrogen can be formed on Pd surfaces. These $[\text{H}_{\text{ad}}]$ species then can act as a reducing agent to promote the intermediate nitrite reduction towards ammonia. Similar enhancement was revealed in a Cu/Ru system, where Ru provided active hydrogen for the nitrite-to-ammonia step of the process.⁵²



It is also known in the literature that the catalytic activity of Cu depends on the exposed crystal facets, morphology, surface functionalization, vacancies, and heterointerfaces, while it also changes with dispersion in the single site \leftrightarrow single atom \leftrightarrow nanocluster \leftrightarrow nanoparticle \leftrightarrow thin layer line.⁵³ There is a dynamic reversible transformation in Cu catalysts during NO₃RR, where oxidation and re-dispersion of Cu transform single-atom sites into clusters and eventually, particles. It was proven that higher Cu loading and more negative electrode potential enhance this process.⁵⁴ Similar *in situ* restructuring accompanied by changing Cu oxidation state during the reduction process was found in a Cu/nickel foam system, where Cu₂O was loaded onto the electrochemically deposited Cu islands under reaction conditions.³⁹ Although XPS and DFT results showed that the improved ammonia yield was the result of the presence of stable Cu(I) species in the latter system, our Cu₂O/BCN possessed only low NO₃RR activity as it can be seen in Fig. 7c.

Also, nitrate reduction activity varied with changing Cu coverage on the Ru/C substrate, where nitrate conversion increased with the increase in Cu coverage between 0 and 0.6 ML Cu, above which no further activity enhancement was seen. It was proposed that the enhancement comes from a synergistic effect of blocking HER sites on the Ru surface and accelerating nitrate-to-nitrite reduction rate, while the underlying Ru substrate likely changes the electronic structure of Cu on the top. The latter effect persisted even up to full surface coverage (1 ML Cu). UHV-XPS results on 1 ML Cu/Ru(0001) indicated a strong interaction between Ru and Cu along with a higher copper electron density compared to that of its bulk counterpart. Furthermore, an upshift in the Cu d-band center was evidenced in Rh-supported 1 ML Cu by DFT calculations, which led to stronger N-containing intermediate adsorption. As a result, both nitrite adsorption, and nitrite reduction were facilitated on Cu/Ru due to the beneficial electronic coupling.⁵² Although similar effects are anticipated in other supported systems, BCN-supported NO₃RR catalysts are largely unexplored.

4. Conclusions

Boron-carbon-nitrogen (B_xC_yN_z) was successfully synthesized through a newly developed hybrid approach. The combination of mechanical alloying and subsequent calcination (pyrolysis) resulted in an amorphous and porous BCN structure. By increasing the annealing temperature, a higher-purity B_xC_yN_z phase was obtained. Afterward, a thin copper layer was deposited on the as-synthesized B_xC_yN_z via electroless plating with and without prior palladium surface activation. By applying Pd²⁺ activation, a pure copper layer was deposited onto the BCN particles, and a Cu@BCN core/shell composite was formed. On the other hand, the activation-less Cu plating resulted in an unevenly deposited Cu₂O-on-BCN structure. The obtained composites were tested in alkaline electrochemical nitrate reduction, and the Cu@BCN composites showed the highest NO₃RR activity compared to those of the as-synthesized BCN and the Cu₂O/BCN samples.

Conflicts of interest

The authors declare no competing interest.

Data availability

The data supporting this article have been included as part of the ESI.† Further data of the measurement results can be requested from the authors.

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